

RoHs

VER	MARK	PR. BY	DESCRIPTION	DATE

NOTES:

1. MATERIAL:

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
UL94V_0, COLOR: BLACK.

CONTACT: COPPER ALLOYS.

COVER: COPPER ALLOYS OR STEEL.

2. PLATING:

UNDERPLATE: NICKEL.

CONTACT AREA: GOLD OVER NICKEL.

SOLDER AREA: TIN OVER NICKEL.

3. MULTIMEDIA CARD COMPATIBLE

SD CARD PIN DEFINE			
Pin#	Name	Type	Description
1	CD/DAT3	I/O/PP	Card Detect/Date Line [Bit3]
2	CMD	PP	Command/Response
3	Vss1	S	Supply voltage ground
4	VDD	S	Supply voltage
5	CLK	I	Clock
6	Vss2	S	Supply voltage ground
7	DAT0	I/O/PP	Date Line [Bit0]
8	DAT1	I/O/PP	Date Line [Bit1]
9	DAT2	I/O/PP	Date Line [Bit2]
10	CD		CARD DETECT
11	WP		WRITE PROTECT

GENERAL TOLERANCES
UNLESS SPECIFIED

.X	±0.35	.X°	±3°
.XX	±0.25	.XX°	±2°
.XXX	±0.15		

MANUFACTURE DWG



深圳市华明通电子有限公司
Shenzhen Huamingtong Electronics Co., Ltd

PART NO.
HMT-SD-006M

TITLE:
SD CARD CONN PUSH SMT

DESIGN: James

CUSTOMER

SIZE
A4

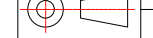
UNITS
MM

CHED: Talen

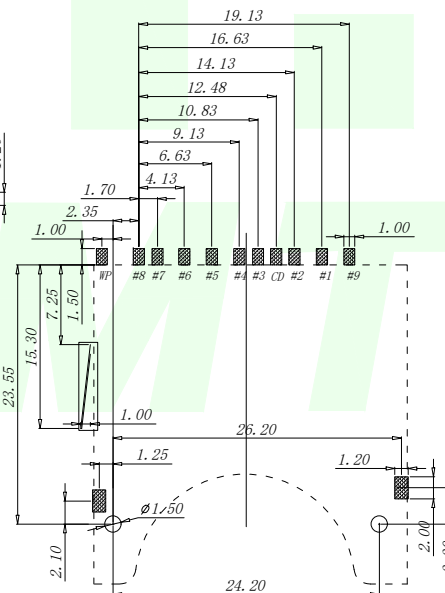
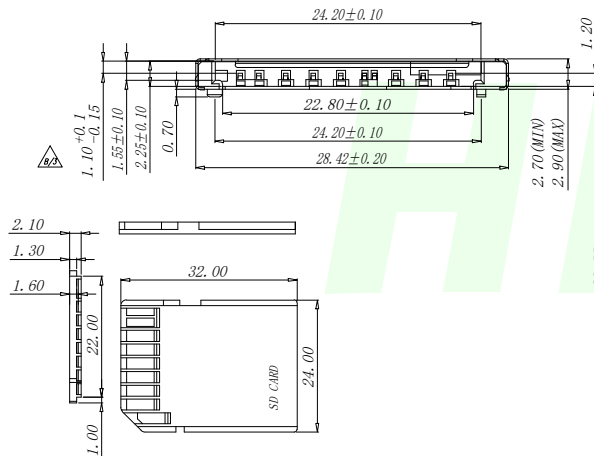
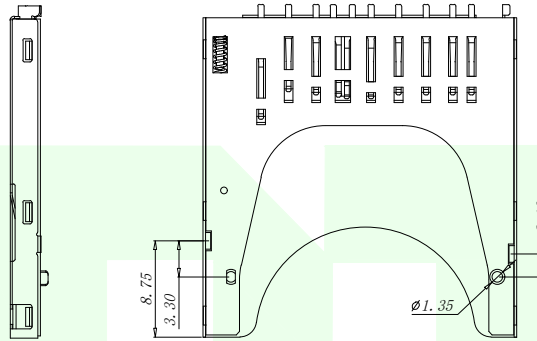
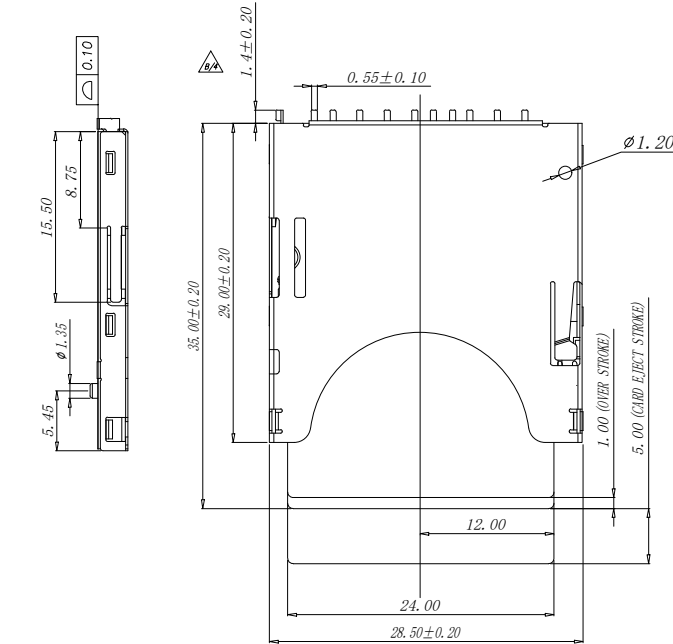
SCALE

SHEET

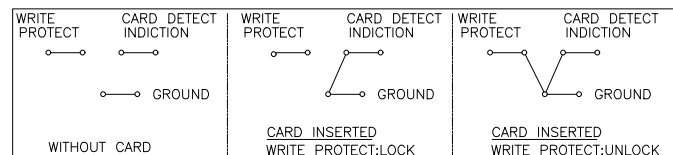
APPD: Sophia



N:A
1/1



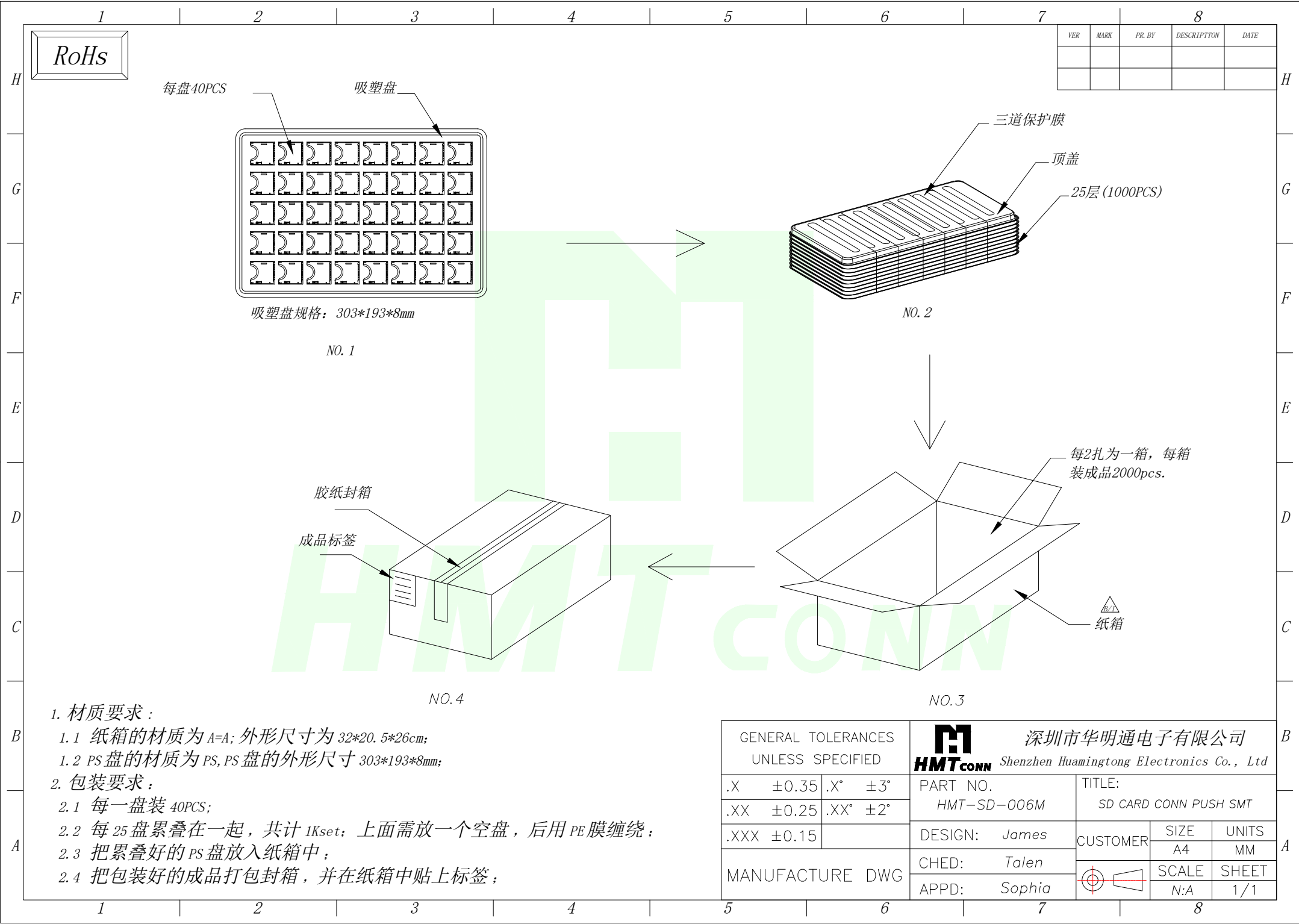
CIRCUIT:

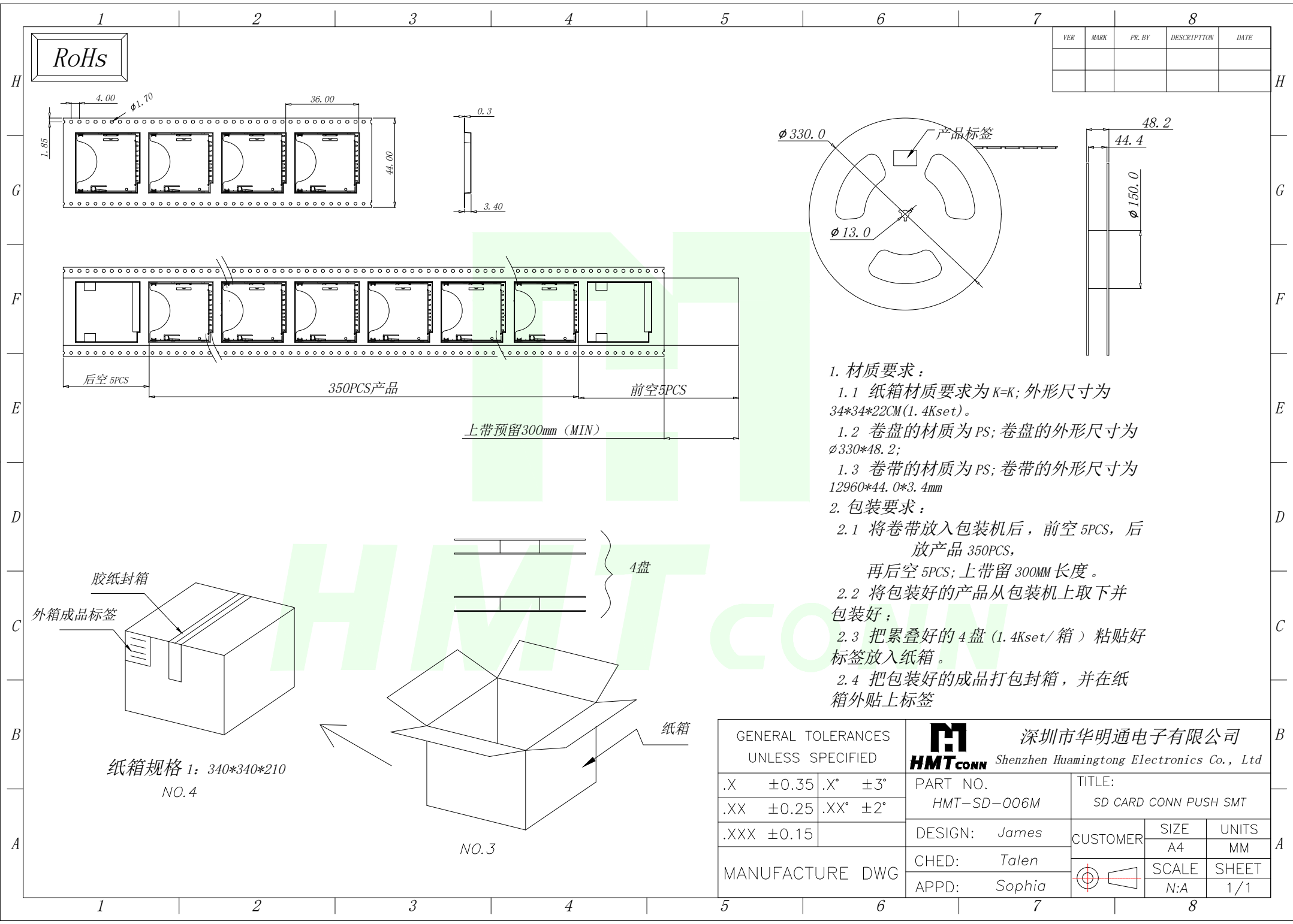


PAD AREA
KEEP OUT AREA

RECOMMENDED PCB LAYOUT

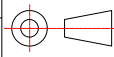
GENERAL TOLERANCE ±0.05





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1. 材质要求：
- 1.1 纸箱材质要求为K=K；外形尺寸为34*34*22CM(1.4Kset)。
- 1.2 卷盘的材质为PS；卷盘的外形尺寸为 $\phi 330*48.2$ ；
- 1.3 卷带的材质为PS；卷带的外形尺寸为12960*44.0*3.4mm
2. 包装要求：
- 2.1 将卷带放入包装机后，前空5PCS，后放产品350PCS，再后空5PCS；上带留300MM长度。
- 2.2 将包装好的产品从包装机上取下并包装好；
- 2.3 把累叠好的4盘(1.4Kset/箱)粘贴好标签放入纸箱。
- 2.4 把包装好的成品打包封箱，并在纸箱外贴上标签

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.XX ±0.25	.XX° ±2°			
.XXX ±0.15		DESIGN: James	CUSTOMER	SIZE A4
MANUFACTURE DWG		CHED: Talen		UNITS MM
		APPD: Sophia		SCALE N:A
				SHEET 1/1